ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,



ON Semiconductor®

FDMB3800N Dual N-Channel PowerTrench® MOSFET

30V, 4.8A, 40m Ω

Features

- Max $r_{DS(on)}$ = 40m Ω at V_{GS} = 10V, I_D = 4.8A
- Max $r_{DS(on)}$ = 51m Ω at V_{GS} = 4.5V, I_D = 4.3A
- Fast switching speed
- Low gate Charge
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability.
- RoHS Compliant

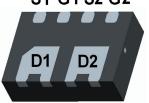


General Description

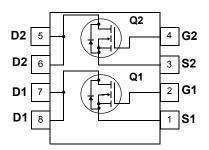
These N-Channel Logic Level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.





MicroFET 3X1.9



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol		Param	neter		Ratings	Units
V_{DS}	Drain to Source V	oltage			30	V
V_{GS}	Gate to Source Vo	ltage			±20	V
	Drain Current	-Continuous	T _A = 25°C	(Note 1a)	4.8	^
ID		-Pulsed			9	Α
D	Power Dissipation		T _A = 25°C	Note 1a)	1.6	10/
P_{D}	Power Dissipation		T _A = 25°C	(Note 1b)	0.75	W
T _J , T _{STG}	Operating and Sto	rage Junction Temper	rature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	80	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	165	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
3800	FDMB3800N	MicroFET3X1.9	7"	8mm	3000 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		24		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24V,$ $V_{GS} = 0V$ $T_{J} = 55^{\circ}C$			1 10	μА
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		-4		mV/°C
		$V_{GS} = 10V, I_D = 4.8A$		32	40	
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 4.3A$		41	51	mΩ
		$V_{GS} = 10V$, $I_D = 4.8A$, $T_J = 125$ °C		43	61	
9 _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 4.8A$		14		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V -45V V - 0V	350	465	pF
C _{oss}	Output Capacitance	V _{DS} =15V, V _{GS} = 0V, f = 1MHz	90	120	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/2	40	60	pF
R_g	Gate Resistance	f = 1MHz	3		Ω

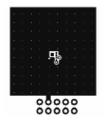
Switching Characteristics

t _{d(on)}	Turn-On Delay Time	.,,	8	16	ns
t _r	Rise Time	V_{DD} = 15V, I_{D} = 1A V_{GS} = 10V, R_{GEN} = 6Ω	5	10	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, K _{GEN} = 052	21	34	ns
t _f	Fall Time		2	10	ns
$Q_{g(TOT)}$	Total Gate Charge at 5V	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 15V$	4	5.6	nC
Q _{gs}	Gate to Source Gate Charge	I _D = 7.5A	1.0		nC
Q _{qd}	Gate to Drain "Miller" Charge		1.5		nC

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain - Source Diode Forward Current			1.25	Α
V_{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = 1.25A (Note 2)	0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _E = 4.8A, di/dt = 100A/μs	17		ns
Q _{rr}	Reverse Recovery Charge	- 1 _F - 4.6A, α//αι - 100A/μS	7		nC

^{1:} $R_{\theta,JA}$ is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



a. 80°C/W when mounted on a 1 in² pad of 2 oz copper



b. 165°C/W when mounted on a minimum pad of 2 oz copper

2: Pulse Test: Pulse Width < $300\mu s$, Duty cycle < 2.0%.

Typical Characteristics T_J = 25°C unless otherwise noted

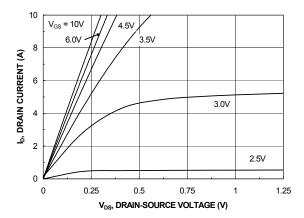


Figure 1. On Region Characteristics

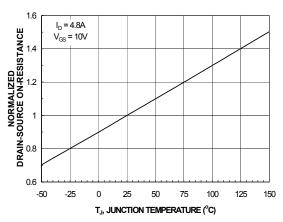


Figure 3. Normalized On - Resistance vs Junction Temperature

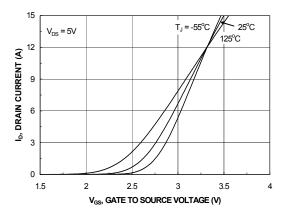


Figure 5. Transfer Characteristics

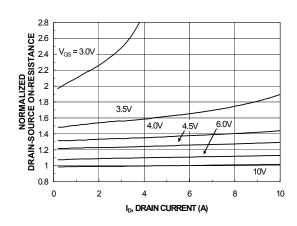


Figure 2. Normalized On - Resistance vs Drain Current and Gate Voltage

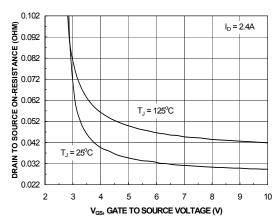


Figure 4. On-Resistance vs Gate to Source Voltage

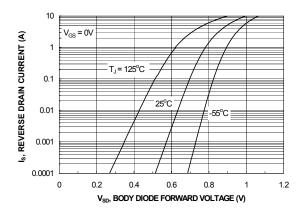


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25°C unless otherwise noted

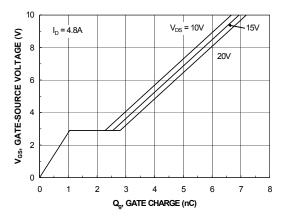


Figure 7. Gate Charge Characteristics

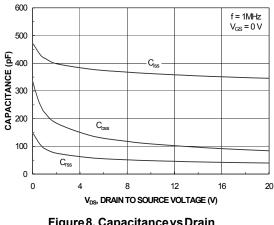


Figure 8. Capacitance vs Drain to Source Voltage

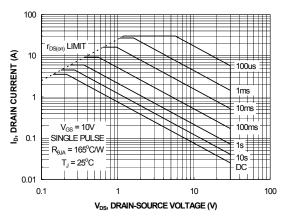


Figure 9. Forward Bias Safe Operating Area

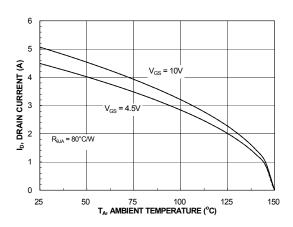


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

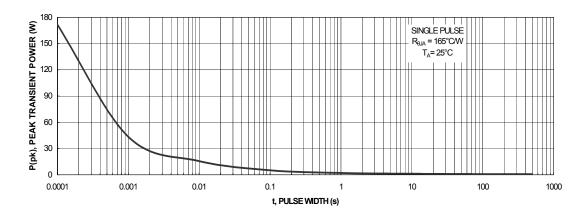


Figure 11. Single Pulse Maximum Power Dissipation

Typical Characteristics T_J = 25°C unless otherwise noted

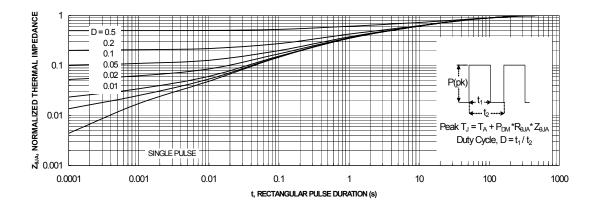
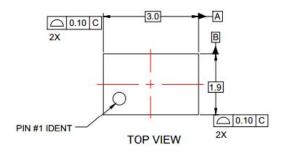
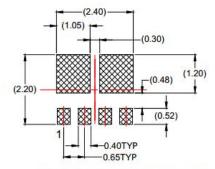


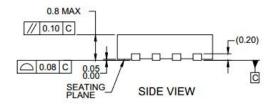
Figure 12. Transient Thermal Response Curve

Dimensional Outline and Pad Layout



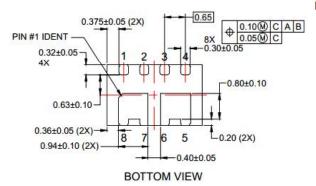


RECOMMENDED LAND PATTERN



NOTES:

- (A) DOES NOT FULLY CONFORM TO JEDED REGISTRATION MO-229.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. DRAWING FILENAME: MKT-MKT-MLP08Hrev3.



Package drawings are provided as a service to customers considering ON Semiconductor components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a ON Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of ON Semiconductor's worldwide terms and conditions, specifically the warranty therein, which covers ON Semiconductor products.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative